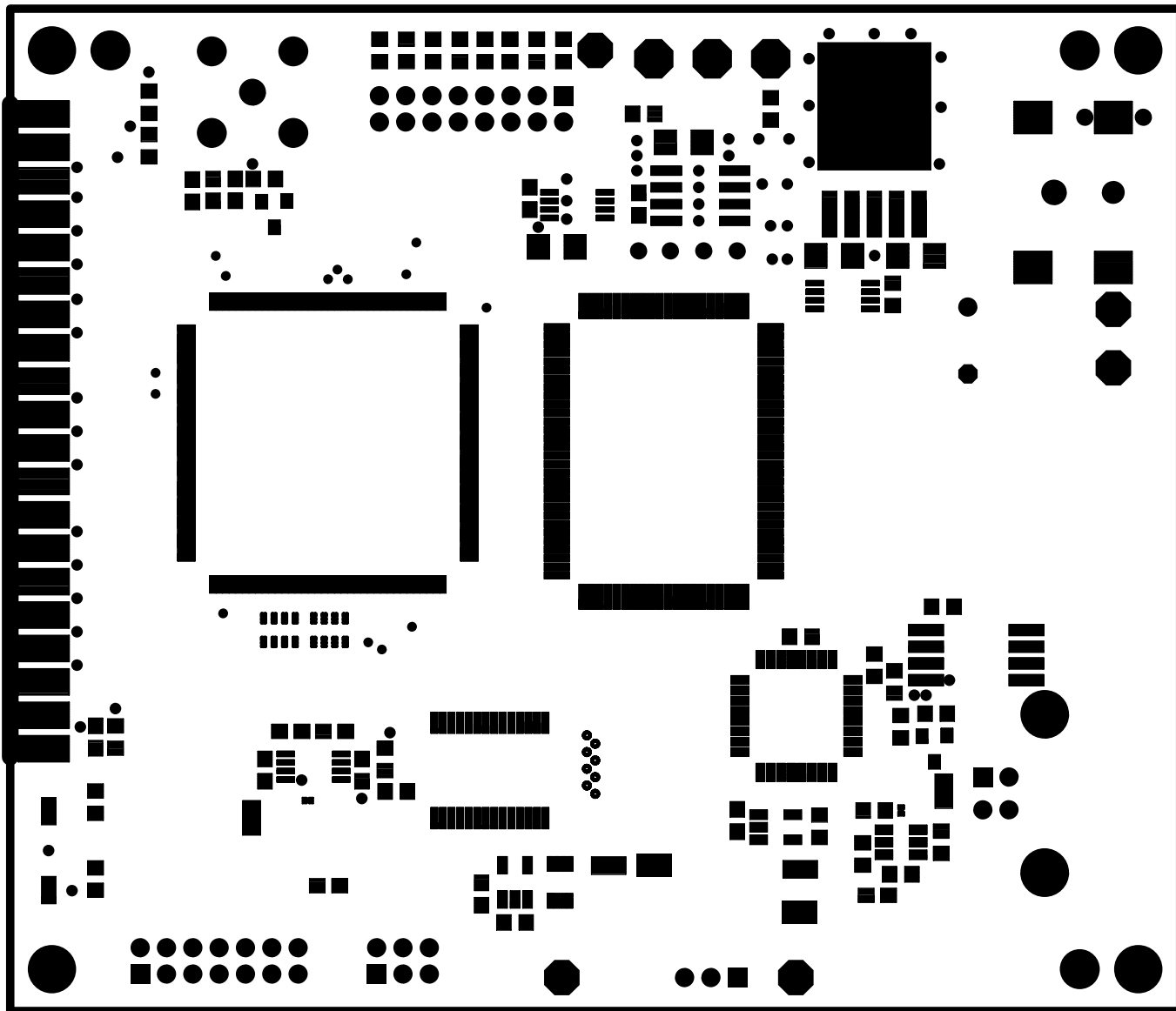
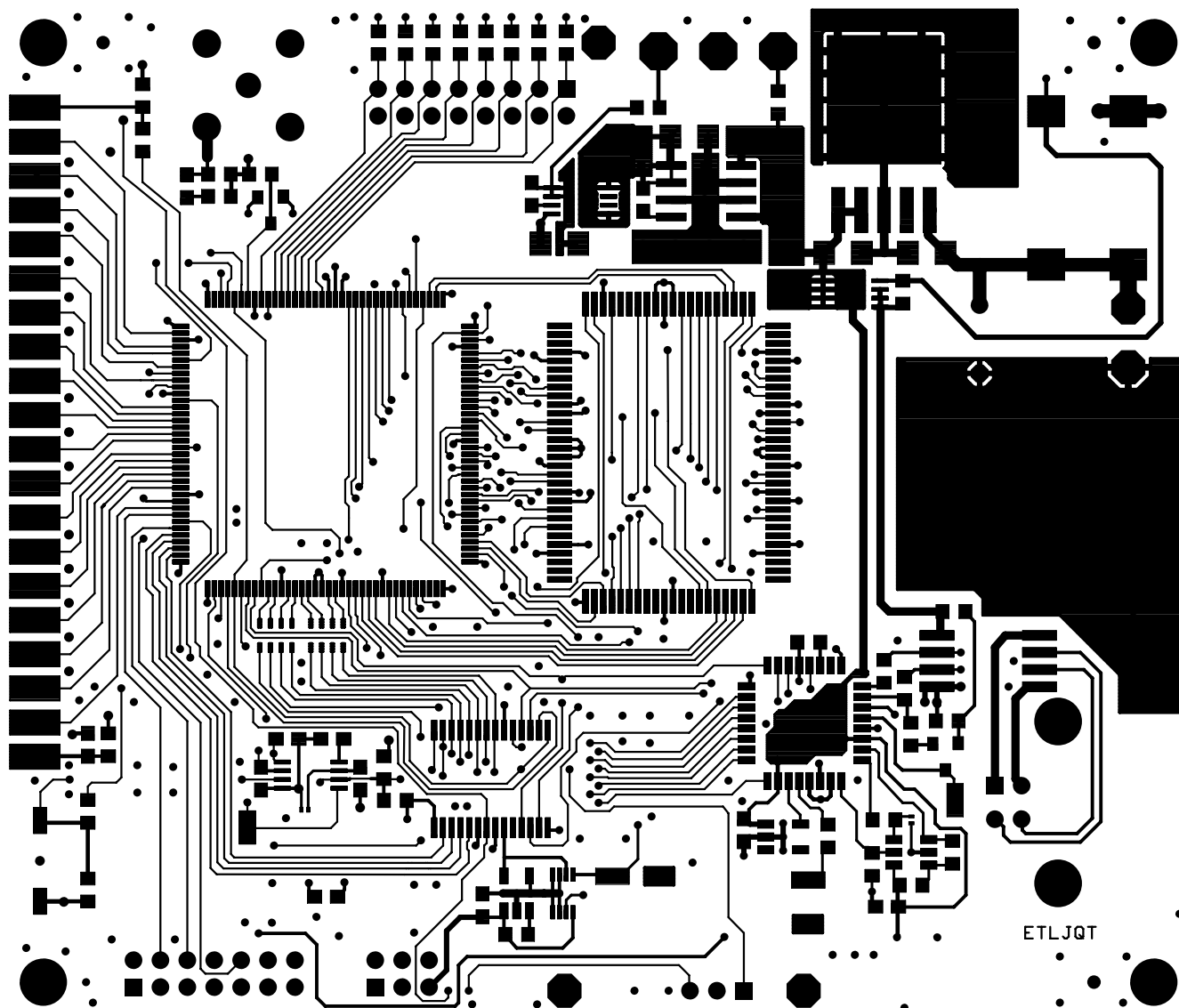


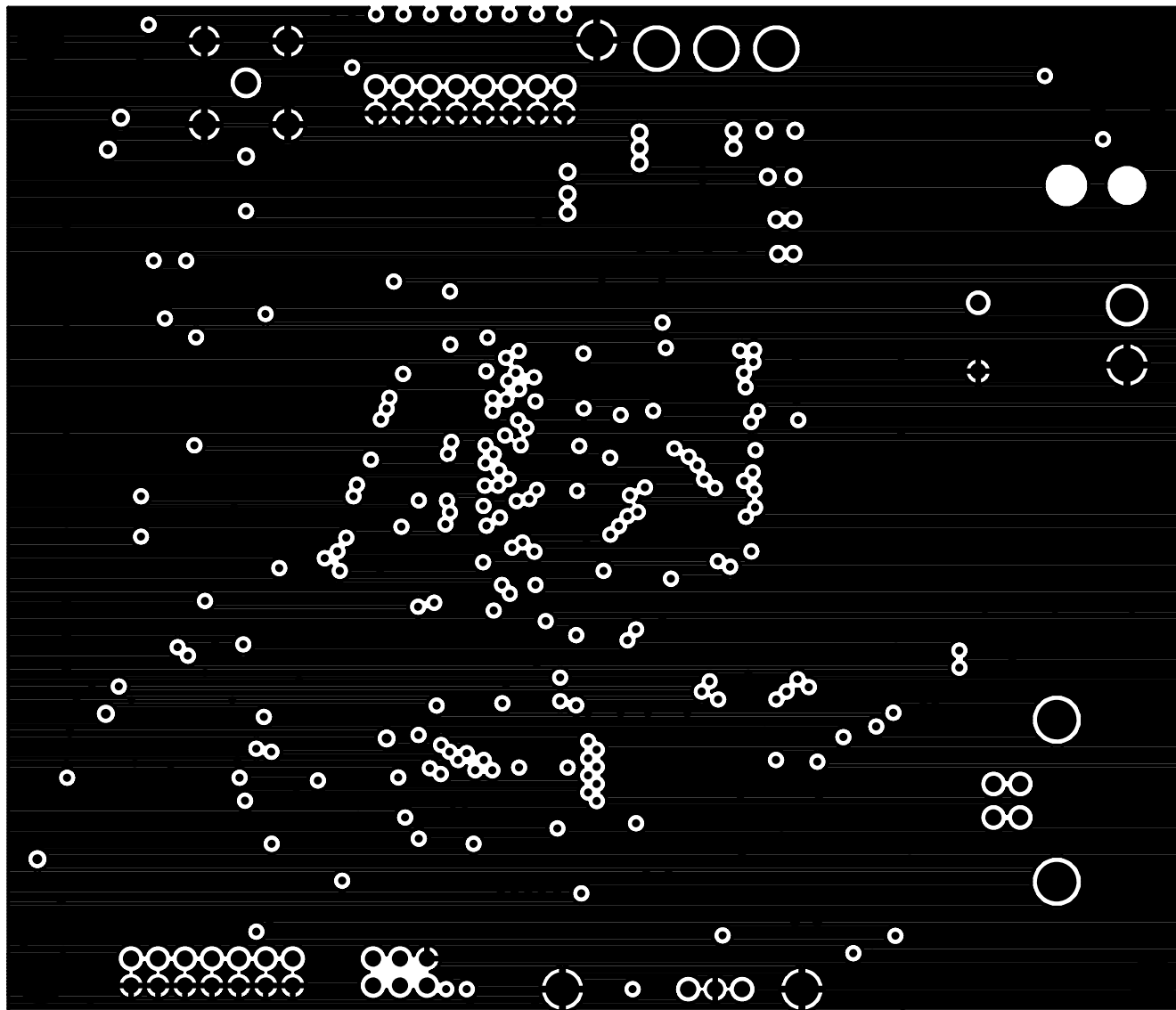
COMPANY			LINEAR TECHNOLOGY CORPORATION		
TITLE		NØ.		REV	
18 BIT DATA ACQUISITION SYSTEM		DC718		C2	
LAYER: TOP SOLDER PASTE					
DSNR:		SHT. 1 OF 10		DATE:	
ETRELEWICZ				24JUL09	



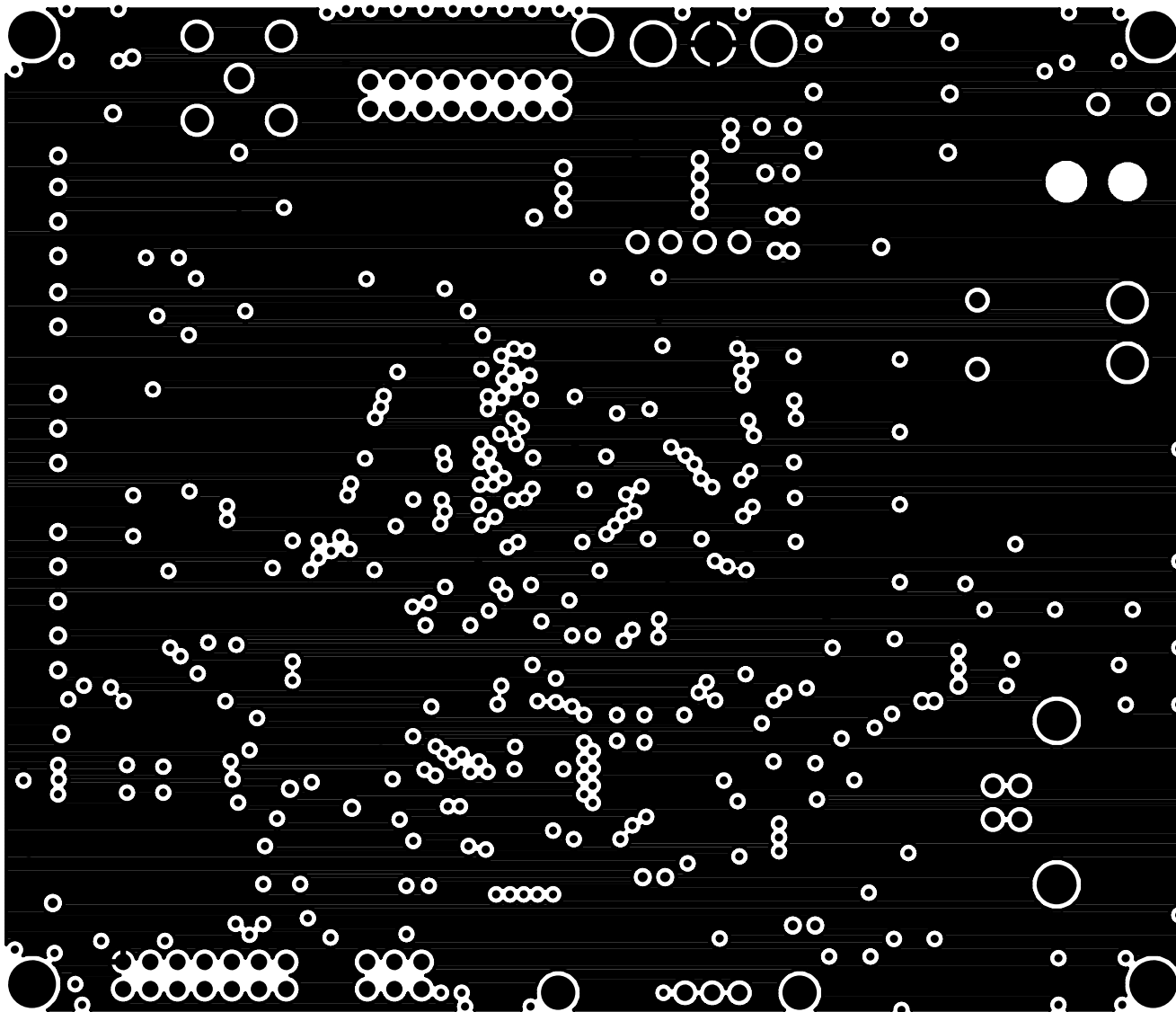
COMPANY LINEAR TECHNOLOGY CORPORATION		
TITLE 18 BIT DATA ACQUISITION SYSTEM	NØ. DC718	REV C2
LAYER: TOP SOLDER MASK		
DSNR: ETRELEWICZ	SHT. 3 OF 10	DATE: 24JUL09



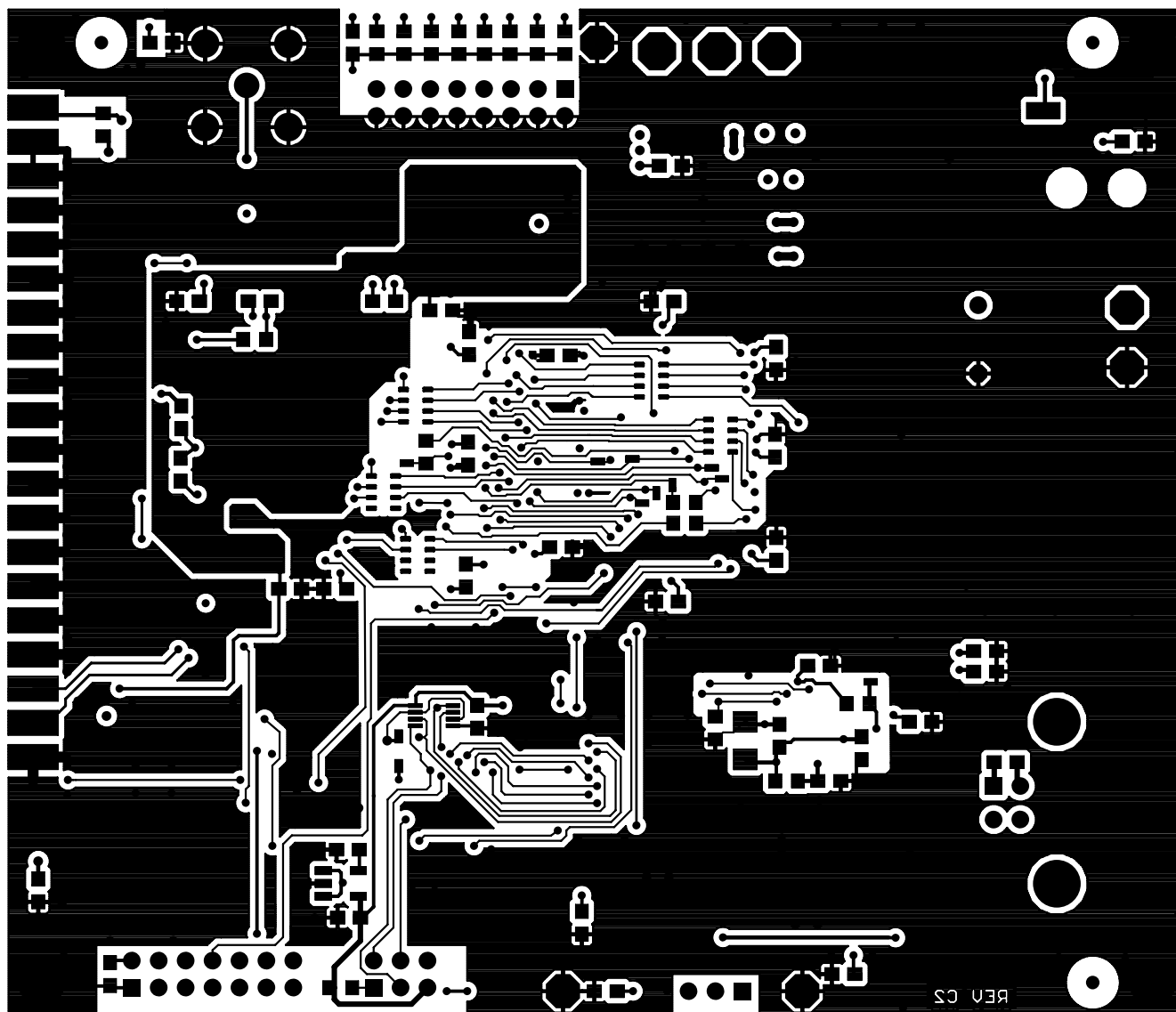
COMPANY LINEAR TECHNOLOGY CORPORATION		
TITLE 18 BIT DATA ACQUISITION SYSTEM	NØ. DC718	REV C2
LAYER: LAYER 1 [TOP]		
DSNR: ETRELEWICZ	SHT. 4 OF 10	DATE: 24JUL09



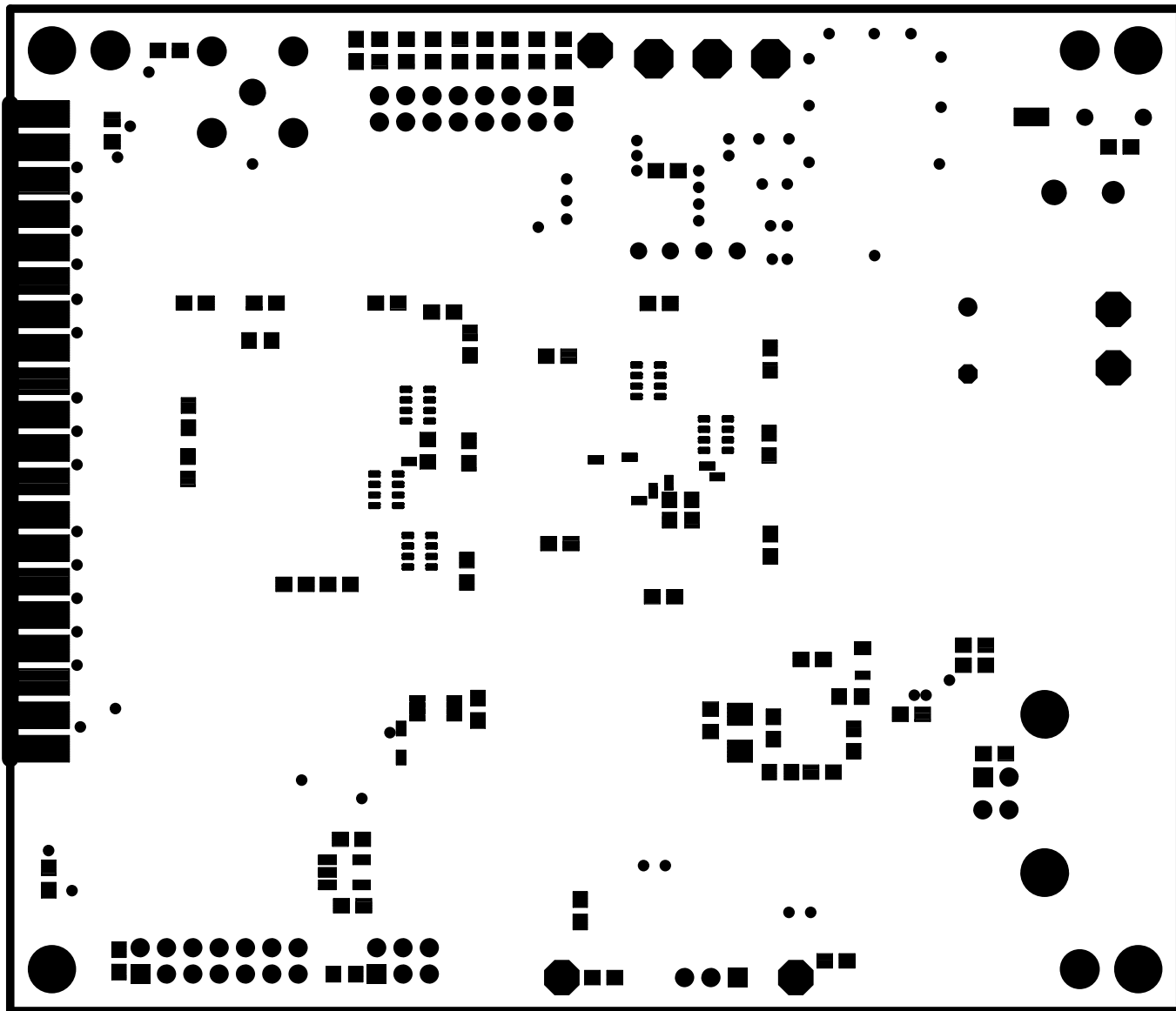
COMPANY			LINEAR TECHNOLOGY CORPORATION		
TITLE		NØ.		REV	
18 BIT DATA ACQUISITION SYSTEM		DC718		C2	
LAYER: LAYER 2 [GND PLANE]					
DSNR:		SHT. 5 OF 10		DATE:	
ETRELEWICZ				24JUL09	



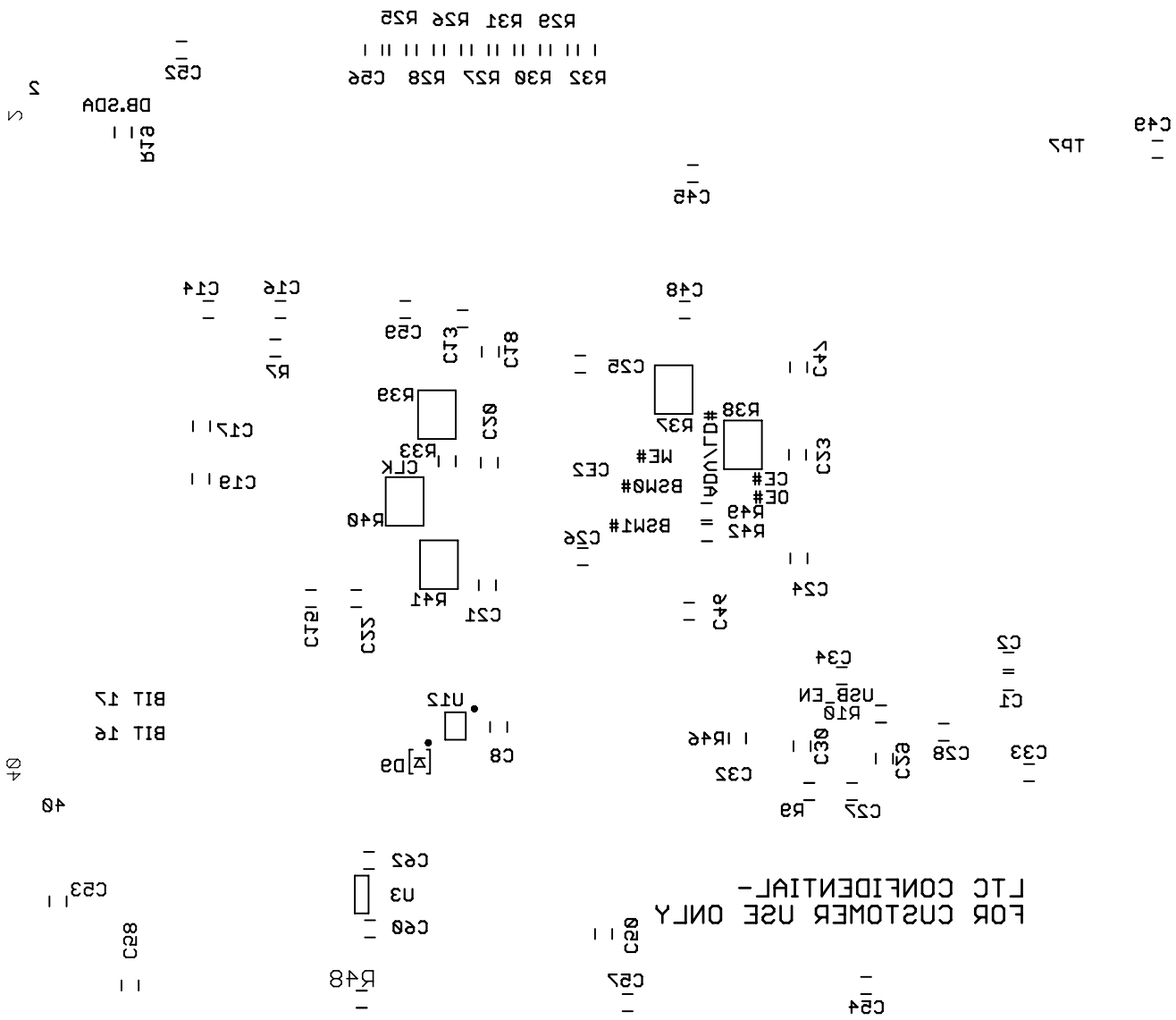
COMPANY			LINEAR TECHNOLOGY CORPORATION		
TITLE		NØ.		REV	
18 BIT DATA ACQUISITION SYSTEM		DC718		C2	
LAYER: LAYER 3 [3.3V PWR PLANE]					
DSNR:		SHT. 6 OF 10		DATE:	
ETRELEWICZ				24JUL09	



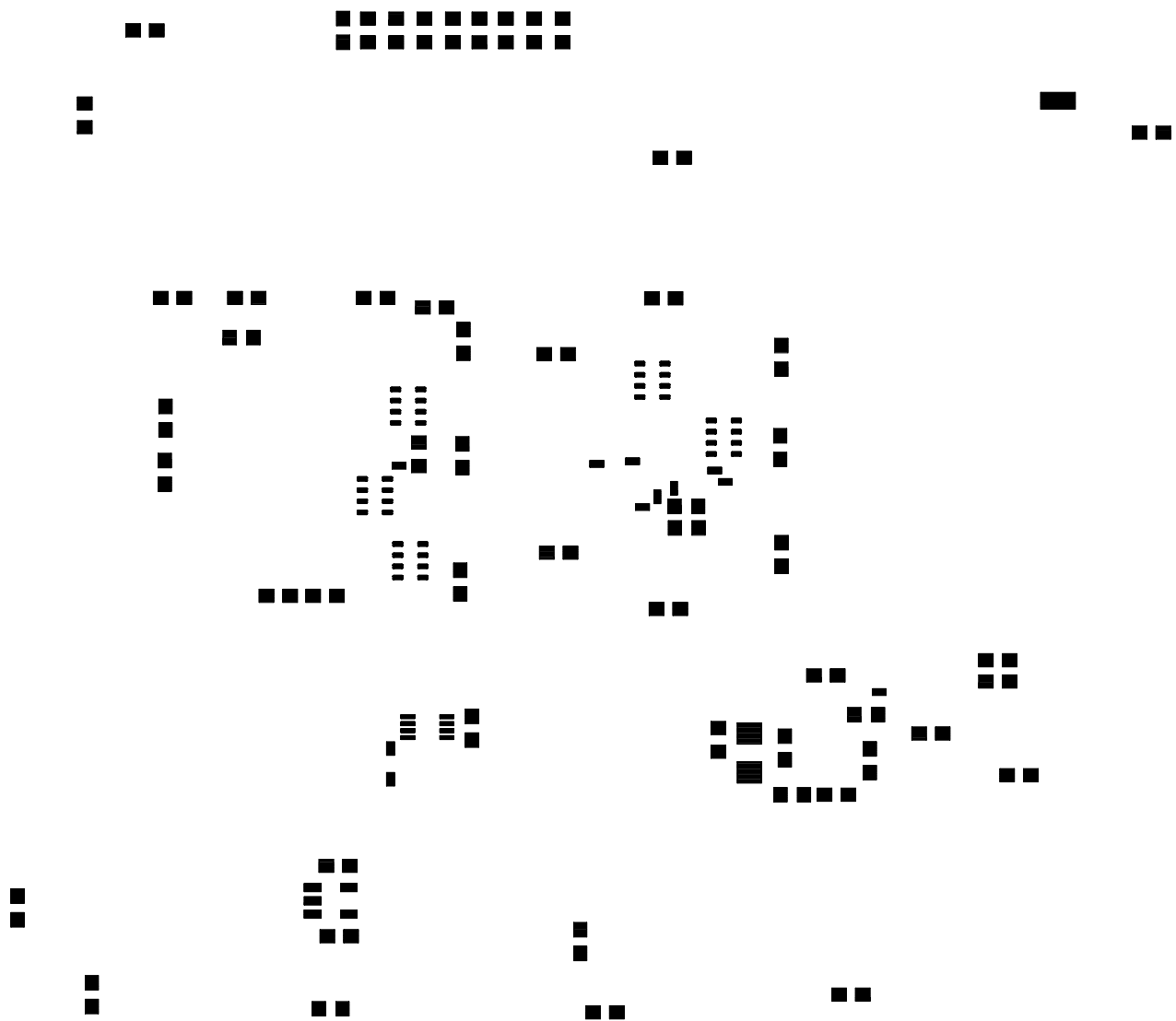
COMPANY LINEAR TECHNOLOGY CORPORATION		
TITLE 18 BIT DATA ACQUISITION SYSTEM	NØ. DC718	REV C2
LAYER: LAYER 4 [BACK]		
DSNR: ETRELEWICZ	SHT. 7 OF 10	DATE: 24JUL09



COMPANY			LINEAR TECHNOLOGY CORPORATION		
TITLE		NØ.		REV	
18 BIT DATA ACQUISITION SYSTEM		DC718		C2	
LAYER: BOTTOM SOLDER MASK					
DSNR:		SHT. 8 OF 10		DATE:	
ETRELEWICZ				24JUL09	



COMPANY			LINEAR TECHNOLOGY CORPORATION		
TITLE		NO.		REV	
18 BIT DATA ACQUISITION SYSTEM		DC718		C2	
LAYER: BOTTOM SILK SREEN					
DSNR:		SHT. 9 OF 10		DATE:	
ETRELEWICZ				24JUL09	



COMPANY			LINEAR TECHNOLOGY CORPORATION		
TITLE		NØ.		REV	
18 BIT DATA ACQUISITION SYSTEM		DC718		C2	
LAYER: BOTTOM SOLDER PASTE					
DSNR:		SHT10 OF 10		DATE:	
ETRELEWICZ				24JUL09	

